ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	© Co	terial Compo opyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	r level p	arts, the	declaration	encompas	ses all low		erials for	which th	e item is an assembly ne manufacturer has eclaration.		
1752-2 1.1	_	Web Site for Informate://www.ipc.org/IPC-1		Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, Hon						ogeneous Materials and Mfg Informat						
Supplier Information																
Company Name * Company Unique ID				Unique ID Au	Response Date *				oonse Doo	ument ID						
SEMTECH CORPORATION 00-847-9941				DUNS		2022-1	0-19									
Contact Name *	Title - Contact		Phone - Cor	tact *	Email	- Contac	t *		Describerto	. 0	A 4 la	.: J D-				
Debbie Mollner Spe		Specialist, Documen	t Control/C	805-498-211	05-498-2111			itech.con	n	Duplicate	e Contact	-> Autho	rizea Re	presentative		
Authorized Representative * Title - R		Title - Representativ	e	Phone - Rep	presentative * E		Email - Representative *			Supplier Comments or URL for Additional Information						
Debbie Mollner		Specialist, Documer	nt Control/C	805-498-211	1	dmolli	ner@sem	itech.con	n							
Requester Item Number		Mfr Item Number	Mfr Item Nan)	Effectiv	e Date	Version	Manufacturi	ng Site	Weight *	UC	DM	Unit Type		
		GS12070-IBE3		UHD-SDI Ge				Oita Opera	a Operations 274.60			J	Each			
Alternate Recommend	lation						Alternate l	Item Comme	Comments							
Manufacturing Proce	ss In	formation														
Terminal Plating / Grid Array Material Term		Terminal B	ase Alloy	J-STD-020 MSL Rating		ing Peak Process Body		Temperature	Max Time	at Peak Tem	perature	of Reflow Cycles				
Tin/Silver/Copper (Sn/Ag/Cu) CU A			CU Alloy			260				30 se	econds	3				
Comments GS12070-IBE3 is a REA	СН-сс	ompliant product, pe	er EU Regi	ulation EC19	07/2006 to includ	de the n	ost rece	nt additio	ons to the	SVHC car	ndidate list	of subst	ances. o	ck dm		

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type *** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a ?RoHS restricted substance?) in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier?s liability and the Company?s remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted **RoHS Declaration *** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature**

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of Measure		Level	Substance Category			Substance	CAS	Evemnt	Weight	Unit of Measure	Tolerance		PPM	
	Name		Material	Weight	Measure		Levei	Substance Category			Substance	CAS	Lxempt	Weight		-	+		
+1 -1	Substrate	+M -M	Substrate	106.700	4mg	+C -C	Supplier		+S	-S	Copper	7440-50-8		41.5063	mg			15,150	
									+S	-s	Glass, oxide, chemicals	65997-17-3		25.9281	mg			94,420	
									+S	-s	1H-pyrrole-2,5-dione. 1.	105391-33-1		15.845	mg			57,701	
									+S	-s	Metal Hydroxide	Trade Secre		15.845	mg			57,701	
									+S	-s	Acrylic Resin	Trade Secre	•	3.7879	mg			13,794	
									+S	-s	Epoxy Resin	Trace Secre		1.5151	mg			5,517	
									+S	-s	Sulfuric acid, barium su	7727-43-7		1.1364	mg			4,138	
									+S	-s	Acrylic ester monomer	Trade Secre	?	0.7576	mg			2,759	
									+S	-s	Talc	14807-96-6		0.0758	mg			276	
									+S	-s	Photo polymerization in	Trtade Secr		0.0758	mg			276	
									+S	-s	Silica	60676-86-0		0.0758	mg			276	
									+S	-s	Phthalocyanine blue	Trade Secre	-	0.0758	mg			276	
									+S	-s	Organic pigment	Trade Secre	÷	0.0758	mg			276	
+1 -1	Purchased Parts	+M -M	Purchased Parts	87.2	mg	+C -C	Supplier		+S	-S	Silicon	7440-21-3		86.6496	mg			315,54	
									+S	-s	Auminum	7429-90-5		0.2614	mg			952	
									+S	-s	Copper	7440-50-8		0.2331	mg			849	
									+S	-s	Tantalum	7440-25-7		0.0559	mg			204	
+1 -1	Underfill Resin	+M -M	Underfill Resin	6.28	mg	+C -C	Supplier		+S	-S	Silicon Dioxide	7631-86-0		3.768	mg			13,722	
									+S	-s	Epoxy Resin	Trade Secre		1.884	mg			6,861	
									+S	-s	Hardener	Trade Secre		0.628	mg			2,287	
+1 -1	Bump	+M -M	Bump	1.9226	mg	+C -C	Supplier		+S	-s	Tin	7440-31-5		1.3292	mg			4,841	
						+C -C	В		+S	-s	Nickel	7440-02-0		0.4344	mg			1,582	
						+C -C	Supplier		+S	-S	Polyimide Resin	Trade Secre		0.102	mg			371	

	+S	-S	Silver		7440-22-4	0.0313	mg		114			
	+S	-S	3, 6, 9-trioxaundecam	et	109-17-1	0.0204	mg		74			
	+S	-\$	2-Hydroxyethyl meth	ас	868-77-9	0.0026	mg		9			
	+S	-\$	Methanol		67-56-1	0.0026	mg		9			
+I -I Soldering Ball +M -M Soldering Ball 72.5 mg +C -C Supp	lier		+5	3 -9	Tin	744	10-31-5	69	9.9625	mg	2	254,77
			+3	s -:	Silver	74	40-22-4	2	.175	mg	7	7,921
			+3	s -	Copper	74	40-50-8	0	.3625	mg		1,320